



NCE N-Channel Enhancement Mode Power MOSFET

Description

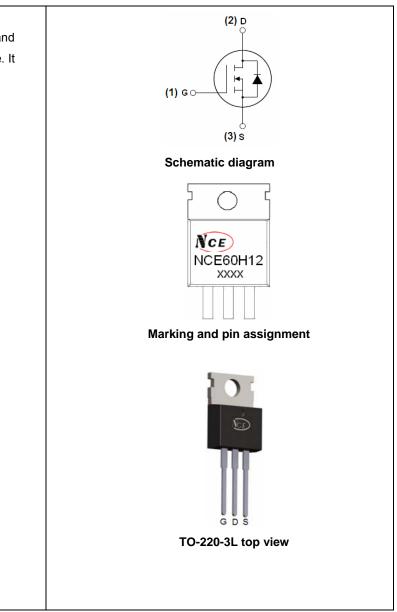
The NCE60H12 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 60V, I_D = 115A$ $R_{DS(ON)} < 7.5m\Omega @ V_{GS} = 10V$ (Typ6.5m Ω)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

100% UIS TESTED!

100% ΔVds TESTED!

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60H12	NCE60H12	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	115	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	81	A
Pulsed Drain Current	I _{DM}	400	A
Maximum Power Dissipation	PD	210	W





Derating factor		1.4	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	1200	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	0.71	°C/W]
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Electrical Characteristics (T_c=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	6.5	7.5	mΩ	
Forward Transconductance	g fs	V _{DS} =5V,I _D =40A	60	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	4700	-	PF	
Output Capacitance	C _{oss}	V _{DS} =30V,V _{GS} =0V, F=1.0MHz	-	450	-	PF	
Reverse Transfer Capacitance	C _{rss}		-	270	-	PF	
Switching Characteristics (Note 4)		·	•	•			
Turn-on Delay Time	t _{d(on)}		-	21	-	nS	
Turn-on Rise Time	tr	V_{DD} =30V, RL=1 Ω	-	39	-	nS	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _{GEN} =2.5Ω	-	70	-	nS	
Turn-Off Fall Time	t _f		-	24	-	nS	
Total Gate Charge	Qg	V/ -20V/L -20A	-	114	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =30A, V _{GS} =10V	-	33	-	nC	
Gate-Drain Charge	Q _{gd}	VGS=10V	-	18	-	nC	
Drain-Source Diode Characteristics		·	•	•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is	-	-	-	110	Α	
Reverse Recovery Time	trr	TJ = 25°C, IF = 40A	-	43	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	93	-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t \leq 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ C$,V_{DD}=30V,V_G=10V,L=0.5mH,Rg=25\Omega

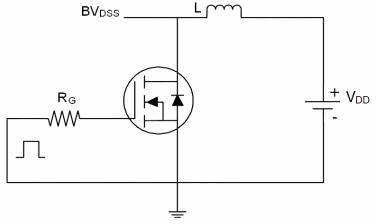


Pb Free Product

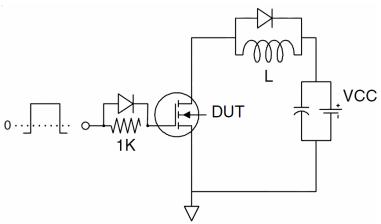


Test circuit

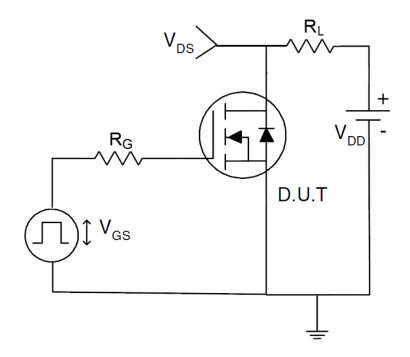
1) E_{AS} test Circuits



2) Gate charge test Circuit:



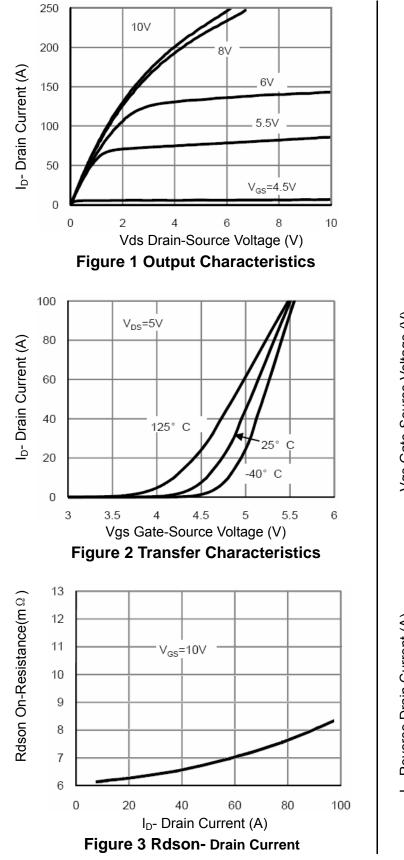
3) Switch Time Test Circuit:

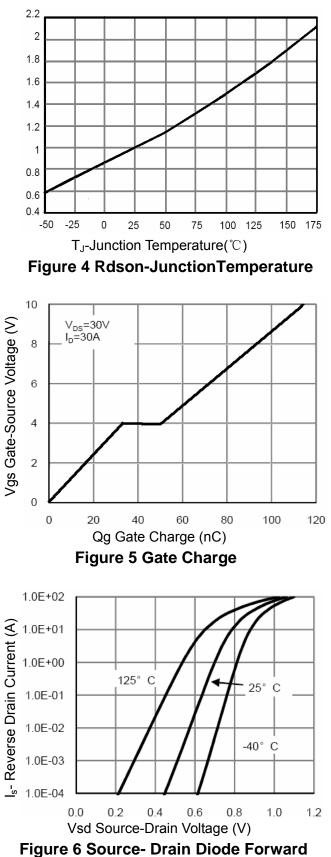






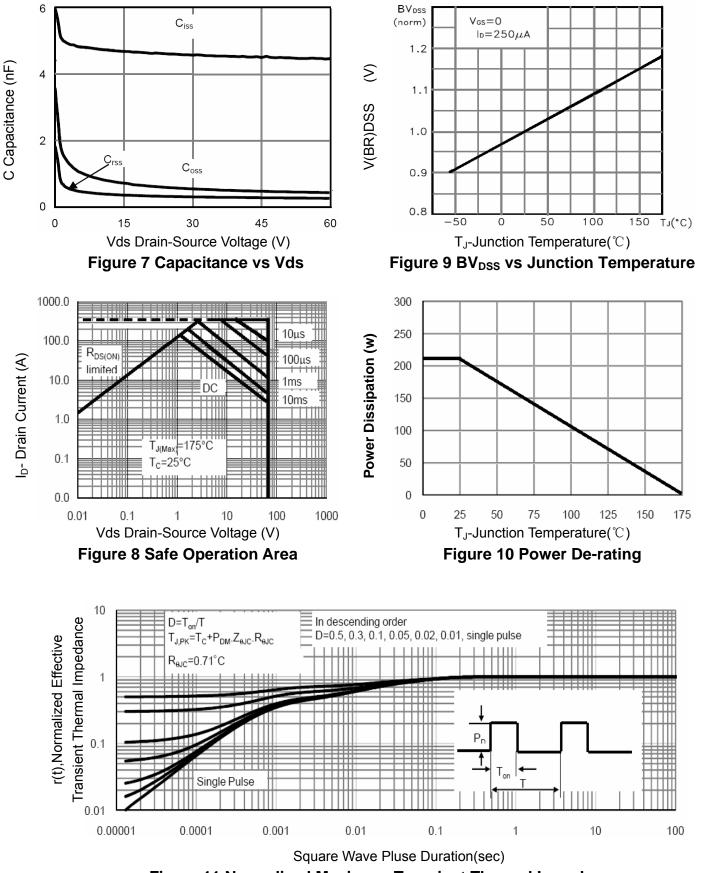
Typical Electrical and Thermal Characteristics (Curves)







NCE60H12

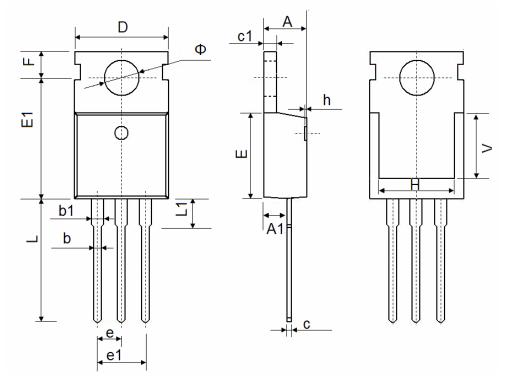






NCE60H12

TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches	
	Min.	Max.	Min.	Max.
А	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
С	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.9500	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
е	2.54	0 TYP.	0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
Н	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 REF.		0.295	REF.
Φ	3.400	3.800	0.134	0.150







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